

Description and Applications

High-Frequency Switching

Synchronous Rectification

DC-DC Converters



Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _A = +25°C
60V	6.5mΩ @ V _{GS} = 10V	14.6A
000	10mΩ @ V _{GS} = 4.5V	11.8A

This MOSFET is designed to minimize the on-state resistance

(RDS(ON)) and maintain superior switching performance, which makes

it ideal for high-efficiency power management applications.

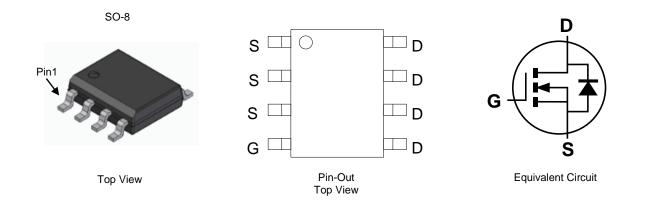
60V N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low RDS(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.076 grams (Approximate)



Ordering Information (Note 4)

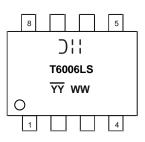
	Part Number	Case	Packaging		
DMT6006LSS-13		SO-8	2500/Tape & Reel		
Notes:	Notes: 1 No purposely added lead Fully FLI Directive 2002/95/FC (RoHS) 2011/65/FLI (RoHS 2) & 2015/863/FLI (RoHS 3) compliant				

No purposely added read. Fully ED Directive 2002/95/EC (Kons), 2017/05/ED (Kons 2) & 2015/05/ED (Kons 3) Compliant.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\begin{array}{l} \label{eq:constraint} \begin{array}{l} \label{eq:constraint} \\ \hline 16006LS = Product Type Marking Code \\ \hline \hline YYWW = Date Code Marking \\ \hline \hline YY = Year (ex: 19 = 2019) \\ \hline WW = Week (01 to 53) \end{array}$



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	Vdss	60	V	
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 5) $V_{GS} = 10V$	T _A = +25°C T _A = +70°C	ID	11.9 9.5	А
Continuous Drain Current (Note 6) V_{GS} = 10V	T _A = +25°C T _A = +70°C	ID	14.6 11.7	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		lом	110	A
Maximum Continuous Body Diode Forward Current (Note 6)	ls	10	A	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle	Ism	110	A	
Avalanche Current, L = 0.1mH		las	28.5	A
Avalanche Energy, L = 0.1mH		Eas	40.7	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.38	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	90.3	°C/W
Total Power Dissipation (Note 6)	PD	2.08	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{ÐJA}	60.1	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	6.5	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS		-	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	1.3	1.74	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Deserver	_	5.0	6.5	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	RDS(ON)	_	6.7	10	mΩ	V _{GS} = 4.5V, I _D = 10A	
Diode Forward Voltage	Vsd	_	0.8	1.2	V	VGS = 0V, IS = 20A	
DYNAMIC CHARACTERISTICS (Note 8)						-	
Input Capacitance	Ciss		2162			$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss		761	_	pF		
Reverse Transfer Capacitance	Crss		58	—			
Gate Resistance	Rg	_	0.7	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	18.1	_		V _{DS} = 30V, I _D = 20A	
Total Gate Charge (V _{GS} = 10V)	Qg	_	34.9	_	nC		
Gate-Source Charge	Q _{gs}	_	6.1	_	nc		
Gate-Drain Charge	Q _{gd}	_	7.3	_			
Turn-On Delay Time	t _{D(ON)}	_	6.0				
Turn-On Rise Time	tR	_	5.4			$\label{eq:VGS} \begin{array}{l} V_{GS} = 10V, \ V_{DD} = 30V, \\ R_G = 3\Omega, \ I_D = 20A \end{array}$	
Turn-Off Delay Time	tD(OFF)		20.4	—	ns		
Turn-Off Fall Time	tF		7.8	—			
Reverse Recovery Time	trr	_	35.8	_	ns		
Reverse Recovery Charge	QRR	_	40.2		nC	I _F = 10A, di/dt = 100A/µs	

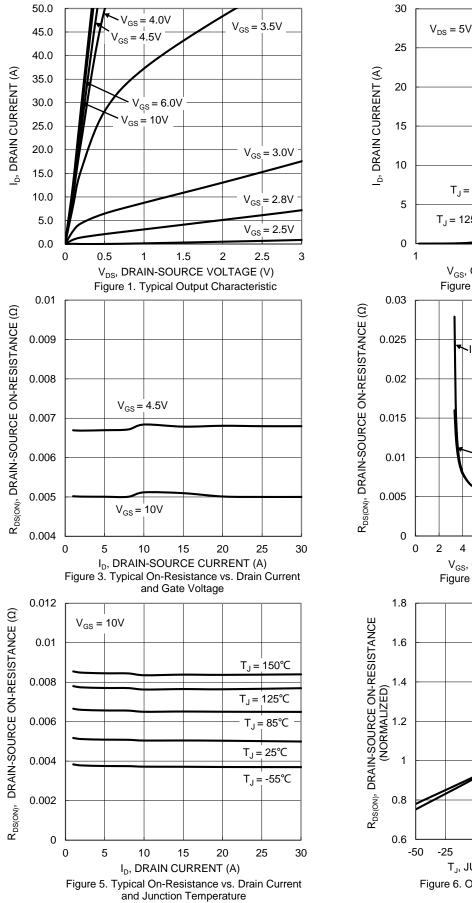
Notes:

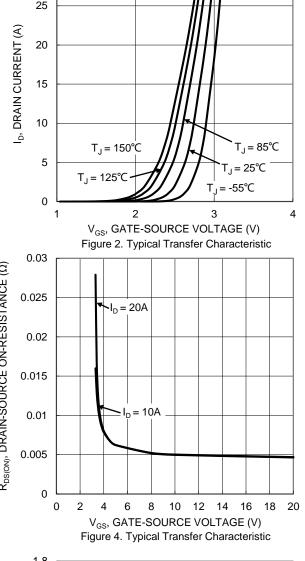
Device mounted on FR-4 PCB, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

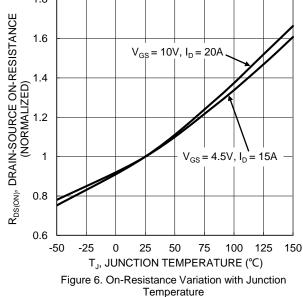
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.



DMT6006LSS



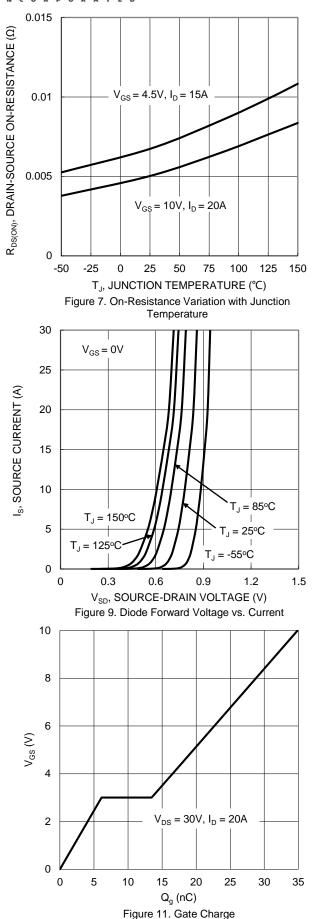


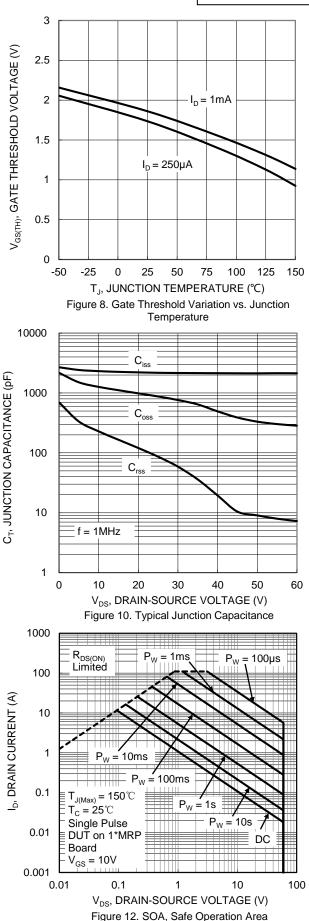


DMT6006LSS Document number: DS42026 Rev. 2 - 2

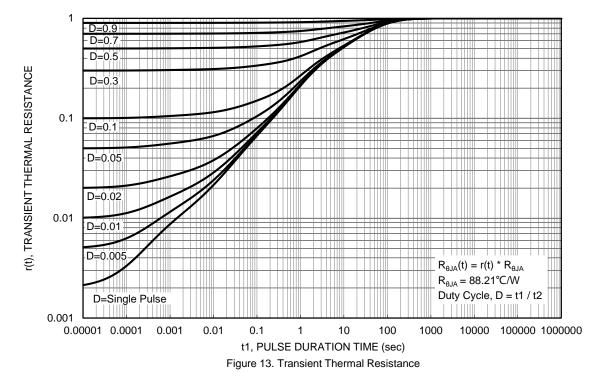








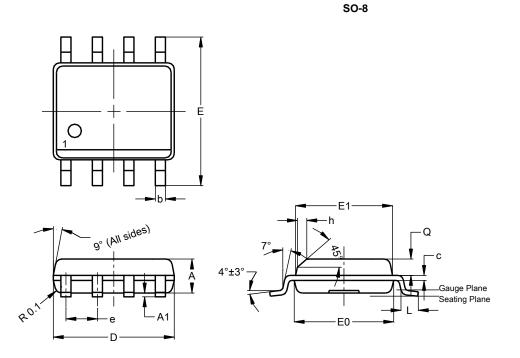






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

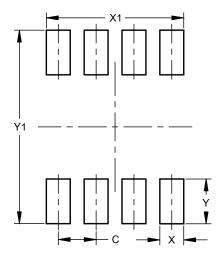


SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h	-		0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			



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